

# N-Channel SupreMOS<sup>®</sup> MOSFET

600 V, 22 A, 165 m $\Omega$ 

## Features

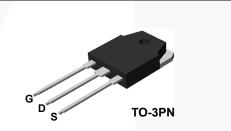
- BV<sub>DSS</sub> > 650 V @ T<sub>J</sub> = 150°C
- $R_{DS(on)}$  = 140 m $\Omega$  (Typ.) @  $V_{GS}$  = 10 V,  $I_D$  = 11 A
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 45 nC)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 196.4 pF)
- 100% Avalanche Tested
- RoHS Compliant

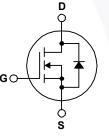
## Application

- PDP TV
- Solar Inverter
- AC-DC Power Supply

# Description

The SupreMOS<sup>®</sup> MOSFET is Fairchild Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.





## MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

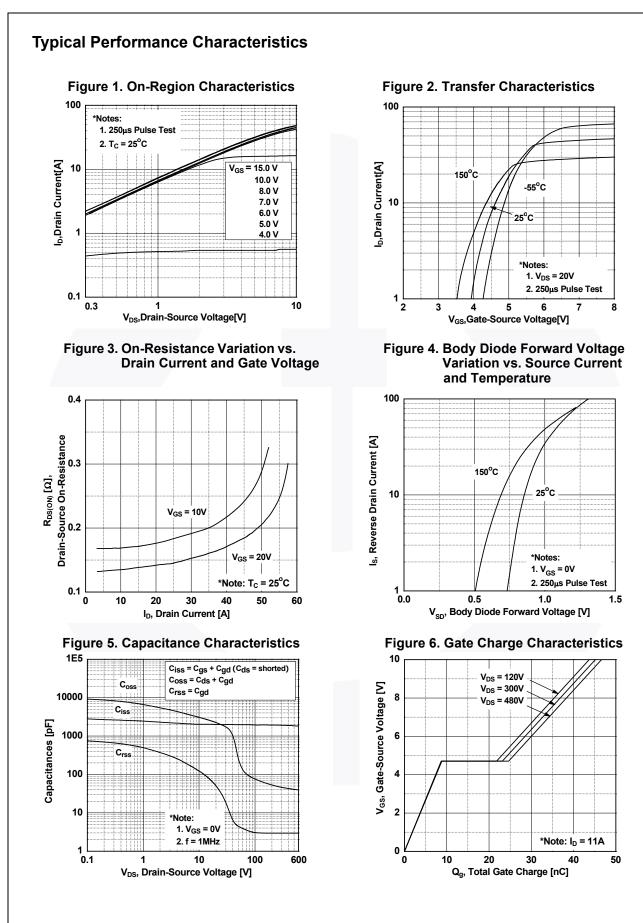
Symbol		FCA22N60N	Unit			
V <sub>DSS</sub>	Drain to Source Voltage	600	V			
V <sub>GSS</sub>	Gate to Source Voltage			±30	V	
I <sub>D</sub>	Droin Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		22	٨	
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		13.8	- A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	66	Α	
E <sub>AS</sub>	Single Pulsed Avalanche	Energy	(Note 2)	672	mJ	
I <sub>AR</sub>	Avalanche Current		(Note 1)	7.3	А	
E <sub>AR</sub>	Repetitive Avalanche Ene	rgy	(Note 1)	2.75	mJ	
dv/dt	MOSFET dv/dt	100	V/ns			
	Peak Diode Recovery dv/dt (Note 3)				20	
P <sub>D</sub>	Dewer Dissingtion	$(T_{\rm C} = 25^{\rm o}{\rm C})$		205	W	
	Power Dissipation	- Derate Above 25°C		1.64	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

# **Thermal Characteristics**

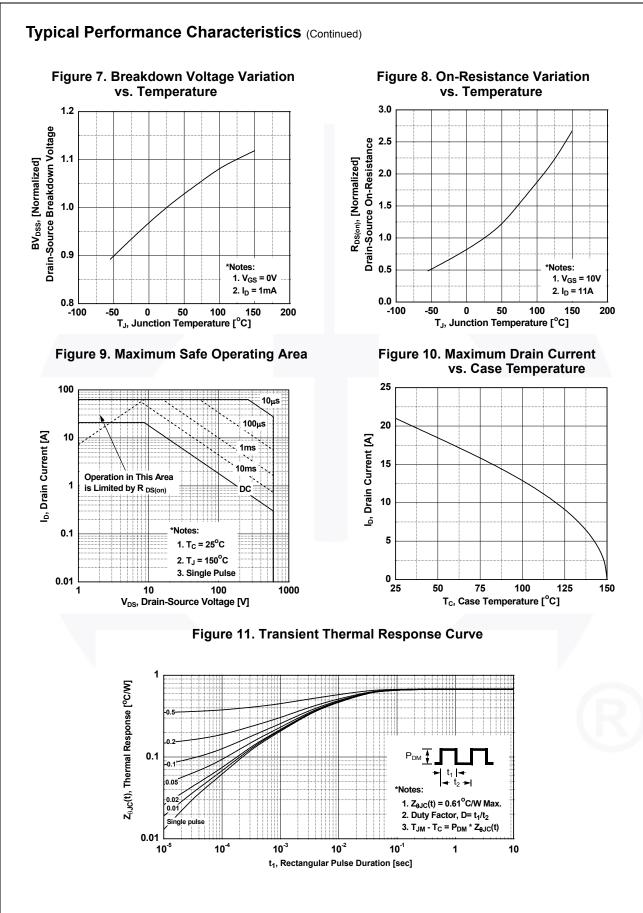
Symbol	Parameter	FCA22N60N	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.61	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	40	- C/W

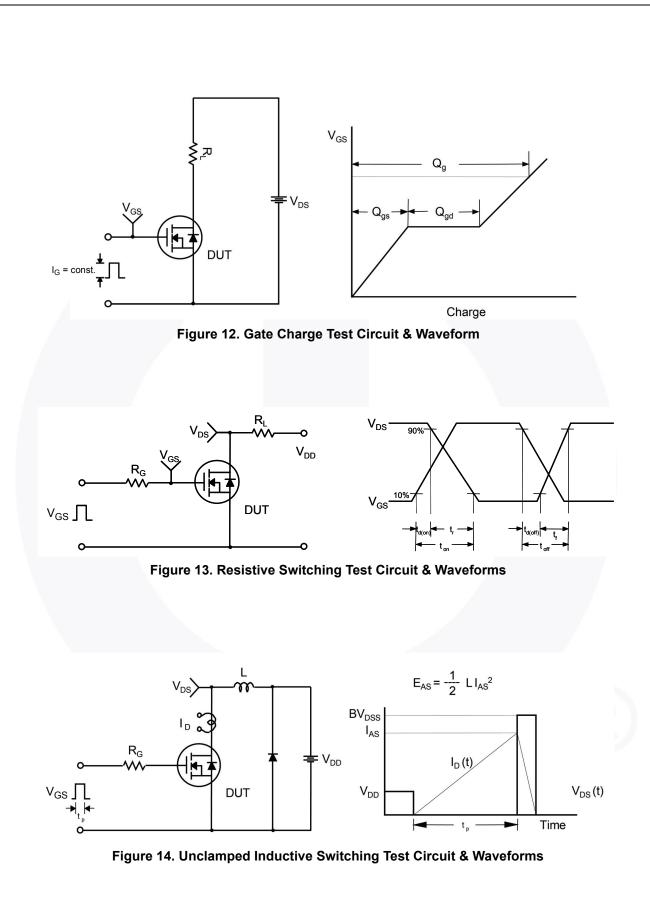
May 2014

	nber	Top Mark	Packag	ge Packing M	lethod	Reel Size	Тар	e Width	Qua	ntity
		TO-3P	N Tube	Э	N/A		N/A	30 units		
Electrica	l Chara	acteristics T <sub>c</sub> =2	25ºC unles	s otherwise note	d.					
Symbol		Parameter		Test Conditions			Min.	Тур.	Max.	Unit
Off Charac	teristics									
			-	$\frac{I_{D} = 1 \text{ mA}, V_{GS} = 0 \text{ V}, T_{J} = 25^{\circ}\text{C}}{I_{D} = 1 \text{ mA}, V_{GS} = 0 \text{ V}, T_{J} = 150^{\circ}\text{C}}$			600 - 650 -	-	-	V
BV <sub>DSS</sub>	Diamito	Drain to Source Breakdown Voltage						-		
ΔΒV <sub>DSS</sub> / ΔΤ <sub>J</sub>	Breakdown Voltage Temperature Coefficient		e	$I_D = 1 \text{ mA}$ , Referenced to 25°C			-	0.68	-	V/ºC
I <sub>DSS</sub>	Zero Gat	Zero Gate Voltage Drain Current		$V_{DS} = 480 V, V_{GS} = 0 V$			-	-	10	μA
	Cata ta I			$V_{DS} = 480 V, T$			-	-	100	~^
I <sub>GSS</sub>	Gate to Body Leakage Current			V <sub>GS</sub> = ±50 V, \	/ <sub>DS</sub> = 0 V		-	-	±100	nA
On Charac	teristics	;								
V <sub>GS(th)</sub>	Gate Threshold Voltage			V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA		2.0	3	4.0	V	
R <sub>DS(on)</sub>	Static Drain to Source On Resistance		tance	$V_{GS} = 10 \text{ V}, \text{ I}_{D}$			-	0.140	0.165	Ω
9FS	Forward Transconductance			$V_{DS} = 20 \text{ V}, I_D = 11 \text{ A}$			-	22	-	S
	horooto	riation								1
Dynamic C								4050		-
C <sub>iss</sub>		pacitance	_	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V,		-	1950		pF	
C <sub>oss</sub>	Output Capacitance		_	f = 1 MHz		-	75.9	-	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance Output Capacitance			(1 - 280)/(1 - 0)/(5 - 1)/(1 - 0)/(1			-	3 43.2	-	pF pF
C <sub>oss</sub>	Effective Output Capacitance		-	$V_{DS} = 380 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$			-	43.2 196.4	-	pF pF
C <sub>oss(eff.)</sub> Q <sub>g(tot)</sub>		te Charge at 10V	-	$V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$ $V_{DS} = 380 V, I_D = 11 A,$ $V_{GS} = 10 V$ (Note 4)		-	45	-	nC	
Q <sub>gs</sub>		Source Gate Charge	-			-	8.7	-	nC	
∽gs Q <sub>gd</sub>		Drain "Miller" Charge				-	14.5	-	nC	
ESR		Equivalent Series Resistance (G-S)		f = 1 MHz			-	1	-	Ω
Switching	Charact	oriotico						1	1	
Switching								10.0		
t <sub>d(on)</sub>		Turn-On Delay Time		V <sub>DD</sub> = 380 V, I <sub>D</sub> = 11 A,		-	16.9	-	ns	
t <sub>r</sub>	Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time			$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$			-	16.7 49	-	ns
t <sub>d(off)</sub> t-								49	-	ns
4					(Note 4)	-	4		ns	
Drain-Sour	rce Diod	e Characteristics								
I <sub>S</sub>	Maximum Continuous Drain to Source Diod			le Forward Current			-	-	22	A
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Fo						-	-	66	A
V <sub>SD</sub>		to Source Diode Forward Voltage		V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 11 A		-	-	1.2	V	
t <sub>rr</sub>		Recovery Time		$V_{GS} = 0 V, I_{SD} = 11 A,$		-	350	-	ns	
Q <sub>rr</sub>	Reverse Recovery Charge			dI <sub>F</sub> /dt = 100 A/µs			-	6	-	μC



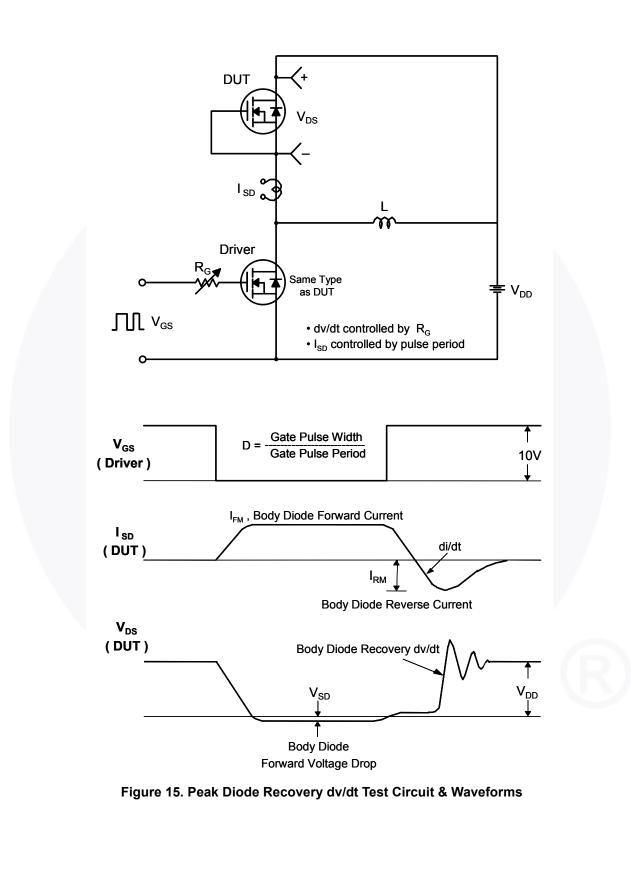
©2009 Fairchild Semiconductor Corporation FCA22N60N Rev. C2

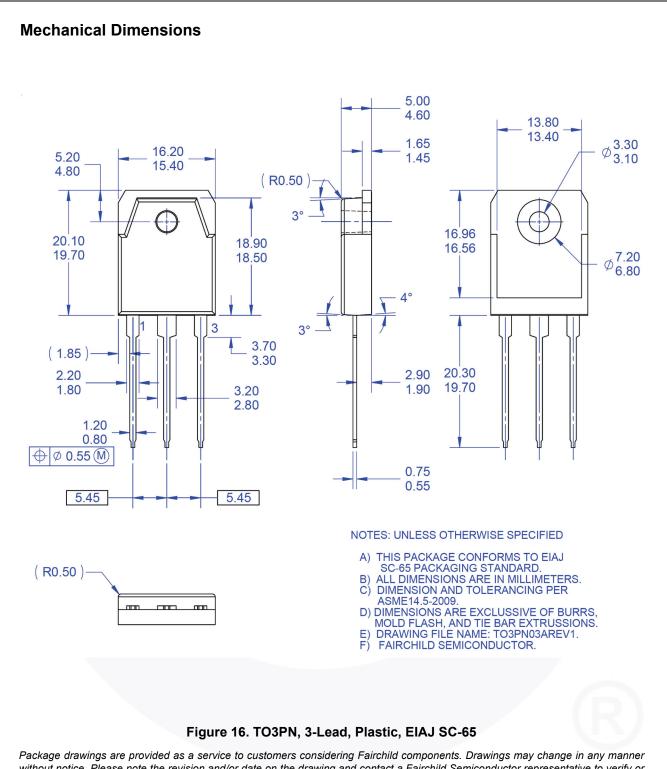




FCA22N60N — N-Channel SupreMOS<sup>®</sup> MOSFET

FCA22N60N — N-Channel SupreMOS<sup>®</sup> MOSFET





without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/package/packageDetails.html?id=PN\_TT3PN-003

FCA22N60N — N-Channel SupreMOS<sup>®</sup> MOSFET



ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death a

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC